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U.S. UTILITY Patent Application

PATENT NUMBER and
ISSUE DATE

APPL NUM 10053785	FILING DATE 01/18/2002	CLASS 205	SUBCLASS 224	GAU 1775	EXAMINER Koehler
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**APPLICANTS: Chen Mike; Dinan Thomas; Robertson Neil;

1775

Koehler

**CONTINUING DATA VERIFIED: RRR. (NONE)

** FOREIGN APPLICATIONS VERIFIED: RRR. (NONE)

PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>
Foreign priority claimed	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no	ATTORNEY DOCKET NO SJO920000194US1
35 USC 119 conditions met	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no	
Verified and Acknowledged Examiners's initials	RRR.	
TITLE : Method for electroplating a body-centered cubic nickel-iron alloy thin film with a high saturation flux density		

U.S. DEPT. OF COMM./PAT. & TM.-PTO-436L (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED 12/15/03		CLAIMS ALLOWED Total Claims 14 Print Claim for O.G. 1.	
ISSUE FEE Amount Due 11630 Date Paid		DRAWING Sheets Drwg. 2 Figs. Drwg. 4 Print Fig. 4.	
<input type="checkbox"/> TERMINAL DISCLAIMER		Assistant Examiner ROBERT R. KOEHLER PRIMARY EXAMINER ART. UNIT 1775 Primary Examiner PREPARED FOR ISSUE Application Examiner	
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